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Features

Configuration

DGD2184M

600V HALF BRIDGE GATE DRIVER IN SO-8

Floating High-Side Driver in Bootstrap Operation to 600V

1.4A Source / 1.8A Sink Output Current Capability

Internal Dead Time of 395ns to Protect MOSFETs Wide Low-Side Gate Driver and Logic Supply: 10V to 20V

Schmitt Triggered Logic Inputs with Internal Pull Down

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

control (i.e. parts gualified to AEC-Q100/101/104/200, PPAP

capable, and manufactured in IATF 16949 certified

Halogen and Antimony Free. "Green" Device (Note 3) For automotive applications requiring specific change

Undervoltage Lockout for High and Low Side Drivers

Extended Temperature Range: -40°C to +125°C

Outputs Tolerant to Negative Transients

Logic Input (IN and SD*) 3.3V Capability

Drives Two N-Channel MOSFETs or IGBTs in Half Bridge

Description

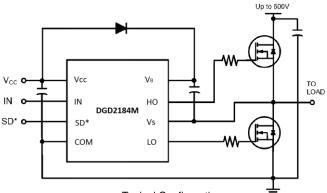
The DIODES™ DGD2184M is a high voltage / high speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half bridge configuration. High voltage processing techniques enable the DGD2184M's high-side to switch to 600V in a bootstrap operation.

The DGD2184M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The DGD2184M has a fixed internal deadtime of 395ns (typ).

The DGD2184M is offered in SO-8 (Type TH) package, the operating temperature extends from -40°C to +125°C.

Applications

- **DC-DC** converters
- **DC-AC** inverters
- AC-DC power supplies
- Motor controls
- Class D power amplifiers



Typical Configuration

Ordering Information (Note 4)

Part Number	Paakaga	Marking	Reel Size (inch)	Tape Width (mm)	Pa	cking
	Package	warking	Reel Size (Inch)	rape width (mm)	Qty.	Carrier
DGD2184MS8-13	SO-8 (Type TH)	DGD2184M	13	12	2,500	Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:





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facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.075 grams (Approximate)

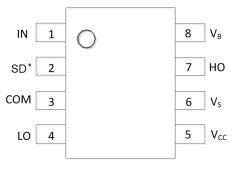
SO-8 (Type TH)



Top View



Pin Diagrams

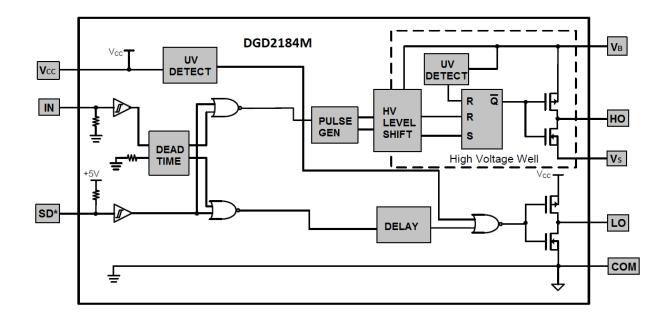


Top View SO-8 (Type TH)

Pin Descriptions

Pin Number	Pin Name	Function
1	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
2	SD*	Logic Input for Shutdown, Enabled Low
3	COM	Low-Side and Logic Return
4	LO	Low-Side Gate Drive Output
5	Vcc	Low-Side and Logic Fixed Supply
6	Vs	High-Side Floating Supply Return
7	НО	High-Side Gate Drive Output
8	VB	High-Side Floating Supply

Functional Block Diagram





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V _B – 24 to V _B + 0.3	V
High-Side Floating Output Voltage	Vно	Vs – 0.3 to V _B + 0.3	V
Offset Supply Voltage Transient	dVs/dt	50	V/ns
Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V
Low-Side Output Voltage	VLO	-0.3 to Vcc + 0.3	V
Logic Input Voltage (IN and SD*)	VIN	-0.3 to V _{CC} + 0.3	V

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	Tstg	-55 to +150]

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply Absolute Voltage	VB	Vs + 10	Vs + 20	V
High-Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High-Side Floating Output Voltage	V _{HO}	Vs	VB	V
Low-Side Fixed Supply Voltage	Vcc	10	20	V
Low-Side Output Voltage	VLO	0	Vcc	V
Logic Input Voltage (IN and SD*)	Vin	0	Vcc	V
Ambient Temperature	TA	-40	+125	С

Note: 6. Logic operation for V_S of -5V to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Notes 7, 8)

_			_			
Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	VIH	2.5			V	$V_{CC} = 10V$ to 20V
Logic "0" Input Voltage	VIL	—	_	0.8	V	Vcc = 10V to 20V
SD* Input Positive Going Threshold	V _{SDTH+}	2.5	—		V	$V_{CC} = 10V$ to 20V
SD* Input Negative Going Threshold	VSDTH-	—	_	0.8	V	Vcc = 10V to 20V
High Level Output Voltage, VBIAS – Vo	Vон	—	_	1.2	V	$I_0 = 0 m A$
Low Level Output Voltage, V _O	Vol	—	_	0.1	V	$I_0 = 20 \text{mA}$
Offset Supply Leakage Current	Ilκ	—	—	50	μA	$V_B = V_S = 600V$
Quiescent VBS Supply Current	IBSQ	20	60	150	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent Vcc Supply Current	lccq	0.4	1.0	1.8	mA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	lin+	—	25	60	μA	IN = 5V, SD* = 0V
Logic "0" Input Bias Current	I _{IN-}	—	—	1.0	μA	IN = 0V, SD* = 5V
VBS Supply Under-Voltage Positive Going Threshold	VBSUV+	8.0	8.9	9.8	V	—
V _{BS} Supply Under-Voltage Negative Going Threshold	V _{BSUV-}	7.4	8.2	9.0	V	—
V _{CC} Supply Under-Voltage Positive Going Threshold	V _{CCUV+}	8.0	8.9	9.8	V	—
Vcc Supply Under-Voltage Negative Going Threshold	Vccuv-	7.4	8.2	9.0	V	—
Output High Short Circuit Pulsed Current	I _{O+}	1.4	1.9	_	Α	V _O = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	lo-	1.7	2.3		А	Vo = 15V, PW ≤ 10µs

7. The V_{IN} and I_{IN} parameters are applicable to the two logic input pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output Notes: pins: HO and LO. 8. For optimal operation, it is recommended that the input pulses (IN and SD*) should have a minimum amplitude of 2.5V with a minimum pulse width of

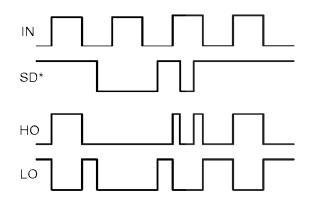
800ns.

AC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, CL = 1000pF, @TA = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton	—	680	900	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	toff	—	270	400	ns	Vs = 0V or 600V
Shut-Down Propagation Delay	tsp	—	180	270	ns	—
Delay Matching, HO & LO Turn-On	t _{DMON}	—	—	90	ns	—
Delay Matching, HO & LO Turn-Off	t DMOFF	—	_	40	ns	$I_{O} = 0A$
Turn-On Rise Time	tR	—	40	60	ns	$V_S = 0V$
Turn-Off Fall Time	tF	—	20	35	ns	Vs = 0V
Deadtime: tdt lo-ho & tdt ho-lo	tот	345	395	445	ns	—



Timing Waveforms





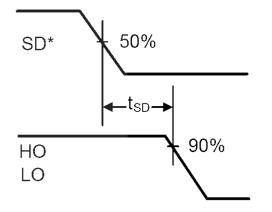
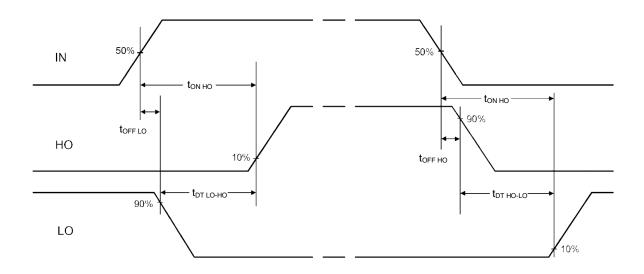


Figure 2. Shutdown Waveform Definitions



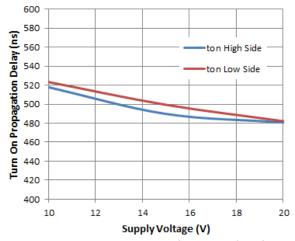
 $\begin{array}{l} \text{Deadtime } t_{\text{DT }\text{LO-HO}} = t_{\text{ON }\text{HO}} + t_{\text{OFF }\text{LO}} \\ t_{\text{DT }\text{HO-LO}} = t_{\text{ON }\text{LO}} - t_{\text{OFF }\text{HO}} \\ \text{Deadtime matching} \\ t_{\text{MDT}} = t_{\text{DT }\text{LO-HO}} - t_{\text{DT }\text{HO-LO}} \end{array}$

Delay matching tDM OFF = tOFF LO - tOFFT HO

Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (@T_A = +25°C, V_{CC} = 15V, unless otherwise specified.)



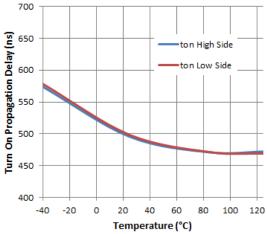


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

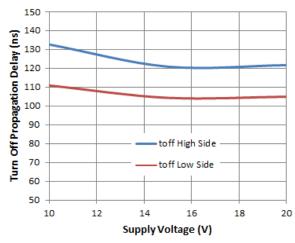


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

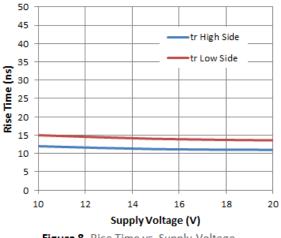


Figure 8. Rise Time vs. Supply Voltage

Figure 5. Turn-on Propagation Delay vs. Temperature

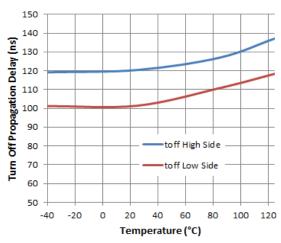


Figure 7. Turn-off Propagation Delay vs. Temperature

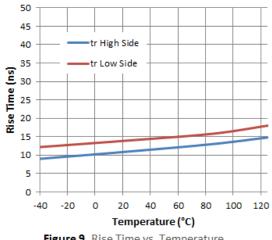
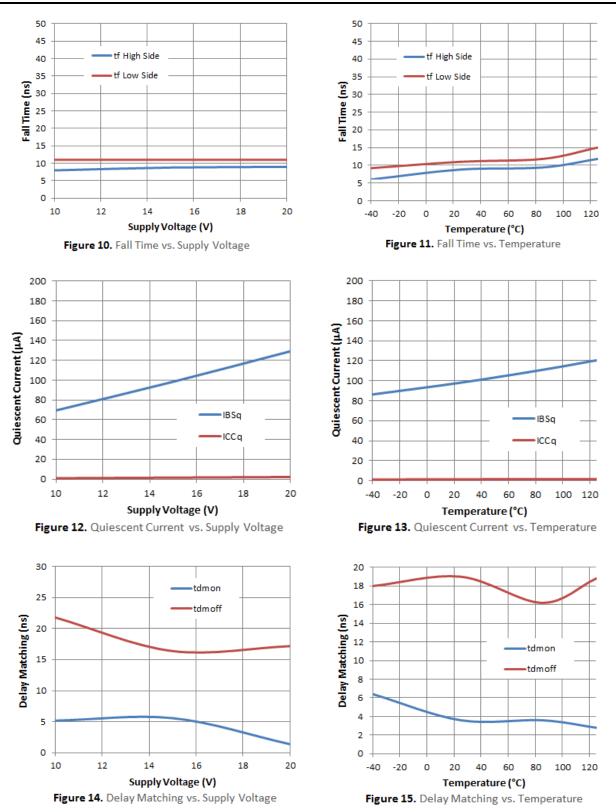
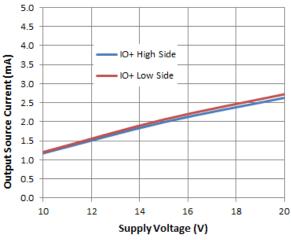


Figure 9. Rise Time vs. Temperature











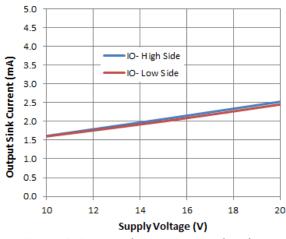


Figure 18. Output Sink Current vs. Supply Voltage

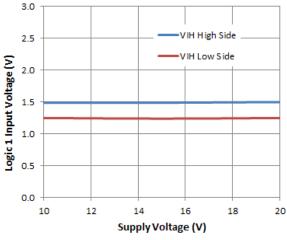
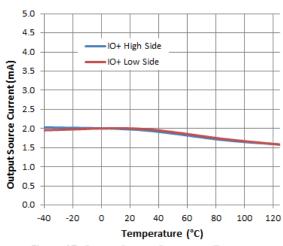


Figure 20. Logic 1 Input Voltage vs. Supply Voltage





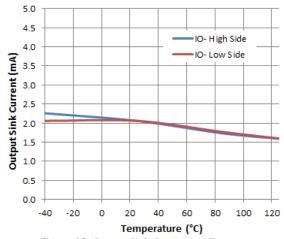


Figure 19. Output Sink Current vs. Temperature

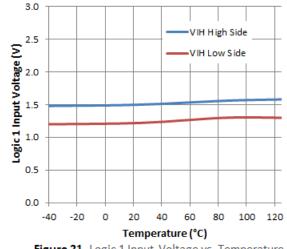
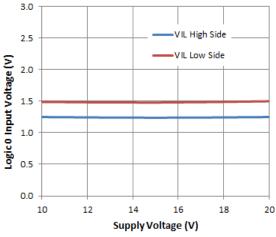
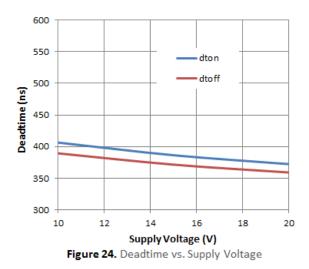


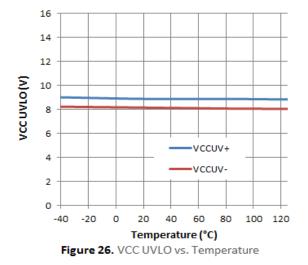
Figure 21. Logic 1 Input Voltage vs. Temperature

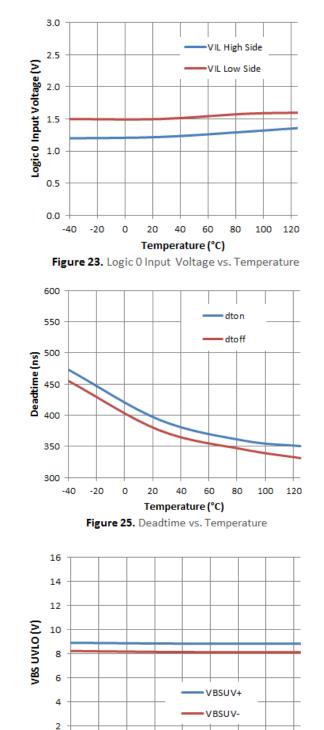












-40 -20 0 20 40 60 80 100 120 Temperature (°C)

Figure 27. VBS UVLO vs. Temperature

0



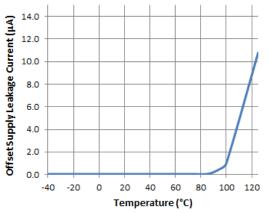
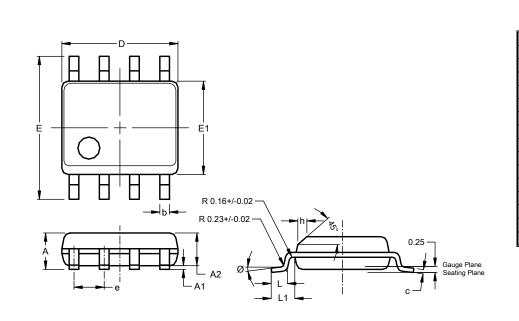


Figure 28. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



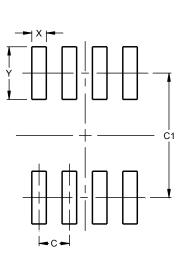
SO-8 (Type TH)

SO-8 (Type TH)

9	SO-8 (Type TH)					
Dim	Min	Max	Тур			
Α	1.35	1.75				
A1	0.10	0.25				
A2			1.45			
b	0.35	0.51				
c	0.190	0.248				
D	4.80	5.00	4.90			
Е	5.80	6.20	6.00			
E1	3.80	4.00	3.90			
e	-		1.27			
h	0.25	0.50				
L	0.41	1.27				
L1	-		1.04			
Ø	0°	8°				
All [All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
C1	5.20
Х	0.60
Y	2.20

DGD2184M Document number: DS40286 Rev. 3 - 2



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